ASSOCIATION CONNECTING ELECTRONICS INDUSTRIES®	<b>Composition De</b> at 2005. IPC, Bannock and Pan-American co	<b>claration</b> ourn, Illinois. A opyright conve	Il rights reserved un ntions.	nder both	This docume level parts, t	ent is a declaration er	on of the substand acompasses all lo	ces within the ma wer level materia	nufacturer lis als for which t	ted item. Note: if the manufacturer	the item is an a has engineering	ssembly with low responsibility.	
	IPC Web Site for Information on IPC-1752 Standard				ype * Declaration Class * tte Class 6 - RoHS Yes/No, Homogeneous Mater				s Materials ar	rials and Mfg Information			
upplier Information													
ompany name*	Company unique ID			1	Unique ID Authority				Response Date*				
nsemi									2024-05-17				
ontact Name	Title - Conta	Title - Contact			Phone - Contact*				Email - Contact*				
Product-Env-Stewards	Product Enviro Compliance				NA			Pro	Product-Env-Stewards@onsemi.com				
uthorized Representative*	Title - Representative			]	Phone - Representative*			Em	Email - Representative*				
roduct-Env-Stewards	Product Enviro Compliance				NA			Pro	Product-Env-Stewards@onsemi.com				
Requester Item Numbe	Requester Item Number Mfr Item		n Number Mfr Item Name			Effective Date	Version	Manufacturing Site		Weight*	UOM	Unit Type	
	2SA194	2SA1943RTU PNP		PNP/15A/230V TO-264 150W		2024-05-17 CPA		СРА	10		mg	Each	
Ianufacturing Proccess Ir	formation												
Terminal Plating / Grid	Terminal Plating / Grid Array Material T		erminal Base Alloy J-STD-020 MSI		Rating	Peak Process Body Temperature M		ature Max Time	at Peak Tem	perature Numb	er of Reflow Cy	cles	
Matte Tin (Sn) - annealed		CU Alloy NA			0 C		30	S	econds 3				
omments													
or more information regarding	material composition	please refer to	page 3										

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	toHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl hthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ce of its products with European Union membe	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	ances per the definitio	on above	Supplier Acceptance	* Accepted					
Exemption: If the declared item does not con applicable exemptions.	ntain RoHS restricted substances per	the definition above	except for defined RoHS exempti	ons, then select the corresponding response i	n the RoHS Declaration above and choose all					
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the					
Supplier Digital Signature Ra	stislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	34.7	mg	Supplier	Silicon (Si)	7440-21-3		34.7	mg
Die Attach	17.0	mg	Supplier	Silver (Ag)	7440-22-4		3.4	mg
			Supplier	Tin (Sn)	7440-31-5		13.6	mg
Lead Frame	7273.81	mg	Supplier	Silver (Ag)	7440-22-4		2.91	mg
			Supplier	Tin (Sn)	7440-31-5		10.9	mg
			Supplier	Copper (Cu)	7440-50-8		7259.9971	mg
Mold Compound-Black	2763.4	mg		Epoxy resin	proprietary data		317.791	mg
			Supplier	Phenolic resins	Proprietary Data		234.889	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		69.085	mg
			Supplier	Carbon Black (C)	1333-86-4		8.2902	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		2133.3445	mg
Plating	21.7	mg	Supplier	Tin (Sn)	7440-31-5		21.7	mg
Wire Bond - Al	2.44	mg	Supplier	Aluminum (Al)	7429-90-5		2.44	mg